

30V N-Channel Enhancement Mode MOSFET

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Description

The AP170N03D uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a Battery protection or in other Switching application.

General Features

V_{DS}=30V I_D =170A

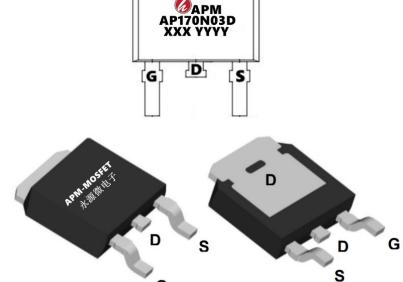
 $R_{DS(ON)} < 2.5m\Omega @ V_{GS}=10V$ (Type: 2.1m Ω)

Application

Battery protection

Load switch

Uninterruptible power supply



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Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
AP170N03D	TO-252-3L	AP170N03D XXXX YYYY	2500

Absolute Maximum Ratings (Tc=25°Cunless otherwise noted)

Symbol	Parameter	Rating	Units
VDS	Drain-Source Voltage	30	V
VGS	Gate-Source Voltage	±20	V
l₀@Tc=25℃	Continuous Drain Current, V _{GS} @ 10V ¹	170	А
I₀@Tc=75℃	Continuous Drain Current, V _{GS} @ 10V ¹	96	А
IDM	Pulsed Drain Current ²	480	А
EAS	Single Pulse Avalanche Energy ³	289	mJ
IAS	Avalanche Current	34	А
P₀@Tc=25℃	Total Power Dissipation ⁴	57	W
P₀@T _A =25℃	Total Power Dissipation ⁴	12	W
TSTG TJ	Operating Junction /Storage Temperature Range	-55 to 150	°C
R₀JA	Thermal Resistance Junction-Ambient ¹	25	°C/W
R₀JC	Thermal Resistance Junction-Case ¹	2.2	°C/W



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Symbol Parameter Conditions Min. Тур. Max. Unit Drain-Source Breakdown Voltage $I_D = 250 \mu A$, $V_{GS} = 0V$ V(BR)DSS 30 V _ _ IDSS $V_{DS} = 30V, V_{GS} = 0V$ Zero Gate Voltage Drain Current _ -1.0 μA IGSS Gate-Body Leakage Current $V_{DS} = 0V, V_{GS} = \pm 20V$ ±100 _ nA VGS(th) Gate Threshold Voltage $V_{DS} = V_{GS}, I_D = 250 \mu A$ 1.2 2.5 V 1.6 $V_{GS} = 10V, I_D = 30A$ 2.1 2.5 mΩ -RDS(ON) Static Drain-Source ON-Resistance⁽⁴⁾ $V_{GS} = 4.5V$, $I_{D} = 20A$ 2.9 3.8 mΩ pF Input Capacitance 5065 C_{iss} --**Output Capacitance** 574 pF Coss $V_{GS} = 0V, V_{DS} = 15V, f = 1MHz$ _ _ C_{rss} 472 pF Reverse Transfer Capacitance --**Total Gate Charge** 97 nC Qg _ _ $V_{GS} = 0$ to 10V $V_{DS} = 15V$, $I_{D} =$ Q_{gs} Gate Source Charge _ 20 nC 30A Gate Drain("Miller") Charge 23 nC Qgd -_ td(on) Turn-On DelayTime 16 ns --30 tr Turn-On Rise Time ns $V_{GS} = 10V, V_{DD} = 15V$ I_D = 30A, R_{GEN} = 3 Ω td(off) Turn-Off DelayTime _ 54 ns tf Turn-Off Fall Time _ 19 ns IS Maximum Continuous Drain to Source Diode Forward Current 120 A _ ISM Maximum Pulsed Drain to Source Diode Forward Current --480 A $V_{GS} = 0V$, $I_{S} = 30A$ V Drain to Source Diode Forward Voltage 1.2 V_{SD} -trr Body Diode Reverse Recovery Time 23 ns -I_F = 30A, di/dt = 100A/us Qrr Body Diode Reverse Recovery Charge 14 nC

Electrical Characteristics (T_J=25 °C, unless otherwise noted)

Note :

1. The data tested by surface mounted on a 1 inch2 FR-4 board with 2OZ copper.

2、 The data tested by pulsed , pulse width $\leq 300 us$, duty cycle $\leq 2\%$

3、The EAS data shows Max. rating . The test condition is VDD=24V,VGS=10V,L=0.5mH,IAS=34A

4、The power dissipation is limited by 175°C junction temperature

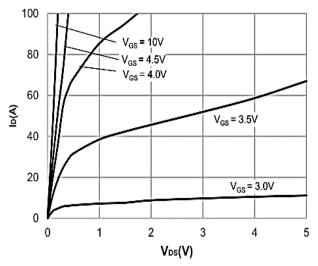
5、The data is theoretically the same as ID and IDM, in real applications, should be limited by total power dissipation.

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Typical Characteristics





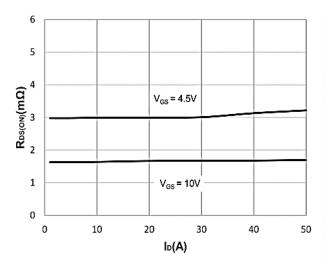


Figure 3: On-resistance vs. Drain Current

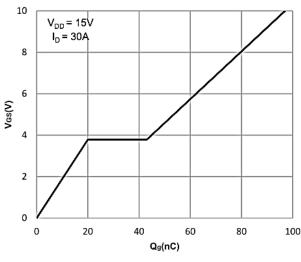


Figure 5: Gate Charge Characteristics

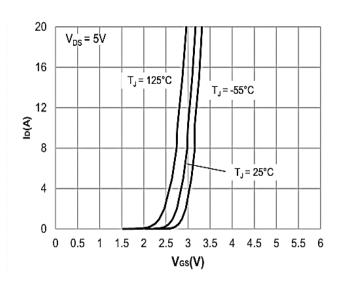


Figure 2: Typical Transfer Characteristics

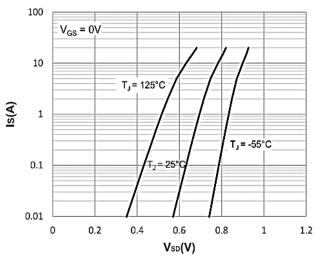
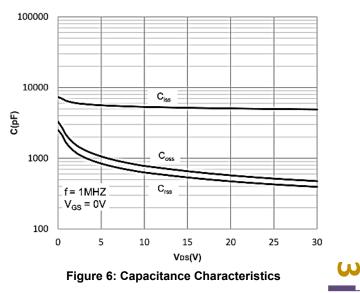
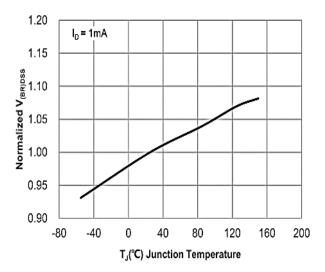


Figure 4: Body Diode Characteristics





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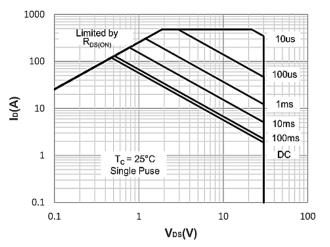


Figure 9: Maximum Safe Operating Area

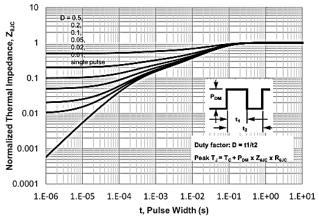
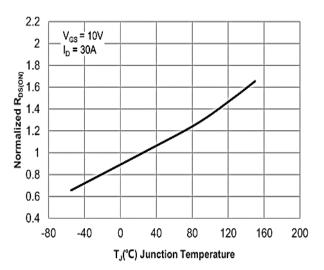
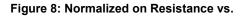


Figure 11: Normalized Maximum Transient





Junction Temperature

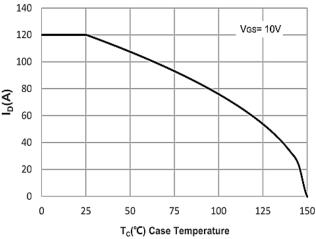
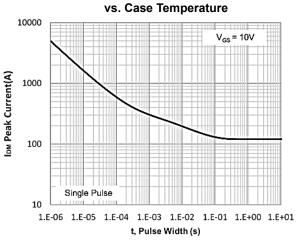


Figure 10: Maximum Continuous Drian Current

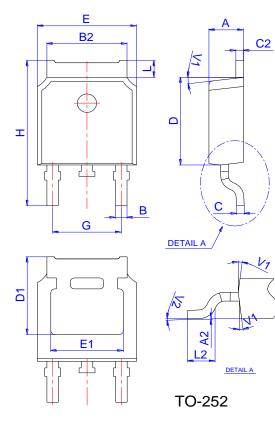






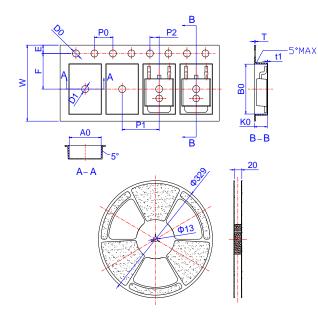
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Package Mechanical Data:TO-252-3L



	Dimensions						
Ref.		Millimeters			Inches		
	Min.	Тур.	Max.	Min.	Тур.	Max.	
А	2.10		2.50	0.083		0.098	
A2	0		0.10	0		0.004	
В	0.66		0.86	0.026		0.034	
B2	5.18		5.48	0.202		0.216	
С	0.40		0.60	0.016		0.024	
C2	0.44		0.58	0.017		0.023	
D	5.90		6.30	0.232		0.248	
D1	5.30REF		0.209REF				
Е	6.40		6.80	0.252		0.268	
E1	4.63			0.182			
G	4.47		4.67	0.176		0.184	
Н	9.50		10.70	0.374		0.421	
L	1.09		1.21	0.043		0.048	
L2	1.35		1.65	0.053		0.065	
V1		7°			7°		
V2	0°		6°	0°		6°	

Reel Spectification-TO-252



	Dimensions					
Ref.	Millimeters			Inches		
	Min.	Тур.	Max.	Min.	Тур.	Max.
W	15.90	16.00	16.10	0.626	0.630	0.634
Е	1.65	1.75	1.85	0.065	0.069	0.073
F	7.40	7.50	7.60	0.291	0.295	0.299
D0	1.40	1.50	1.60	0.055	0.059	0.063
D1	1.40	1.50	1.60	0.055	0.059	0.063
P0	3.90	4.00	4.10	0.154	0.157	0.161
P1	7.90	8.00	8.10	0.311	0.315	0.319
P2	1.90	2.00	2.10	0.075	0.079	0.083
A0	6.85	6.90	7.00	0.270	0.271	0.276
B0	10.45	10.50	10.60	0.411	0.413	0.417
K0	2.68	2.78	2.88	0.105	0.109	0.113
т	0.24		0.27	0.009		0.011
t1	0.10			0.004		
10P0	39.80	40.00	40.20	1.567	1.575	1.583

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Edition	Date	Change
REV1.0	2023/6/21	Initial release

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